

3.65x6.15mm SINGLE CHIP LED LIGHT BAR

### **Features**

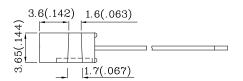
- •FLAT RECTANGULAR LIGHT EMITTING SURFACE.
- •SINGLE COLOR.
- •IDEAL AS FLUSH MOUNTED PANEL INDICATORS.
- EXCELLENT ON/OFF CONTRAST.
- •LONG LIFE SOLID STATE RELIABILITY.
- •THIS SERIES ARE TIN-DIPPED.
- •Rohs Compliant.

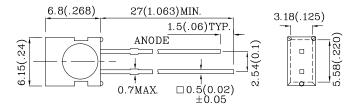




# Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25(0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.





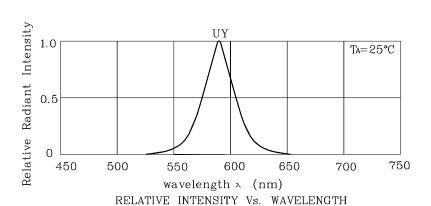
Absolute Maximum Rating (TA=25°C)	UY (GaAsP/GaP)	Unit			
Reverse Voltage	VR	5	V		
Forward Current	IF	30	mA		
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	140	mA		
Power Dissipation	Рт	75	mW		
Operating Temperature	TA	-40 ~ +85	0.0		
Storage Temperature	Tstg	-40 ~ +85	°C		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

Operating Characteristi (TA=25°C)	UY (GaAsP/GaP)	Unit	
Forward Voltage (Typ.) (IF=10mA)	$V_{\rm F}$	1.95	V
Forward Voltage (Max.) (IF=10mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=10mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (IF=10mA)	λ D	588	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=10mA)	Δλ	35	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	20	pF

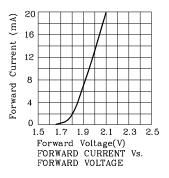
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=10mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
EUY21D	Yellow	GaAsP/GaP	Yellow Diffused	1	3.8	590	100°
Published Date : MAI	R 21, 2008	Drawi	ing No : SDSA3725	V3	Che	ecked : B.L.LIU	P.1/4

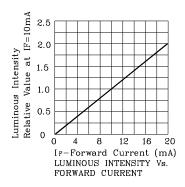


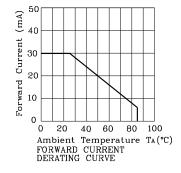
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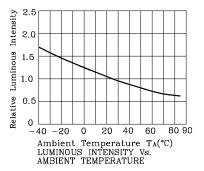


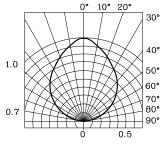
# **♦** UY









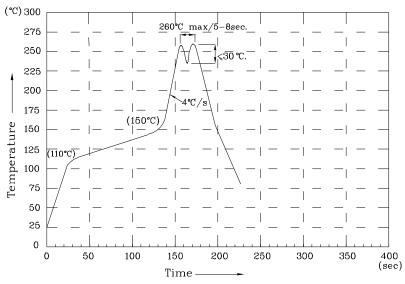


SPATIAL DISTRIBUTION



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Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C $\sim$ 260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree  $^{\circ}$ C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4. No more than once.

## Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity/ Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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EUY21D

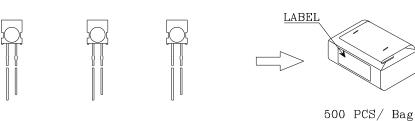
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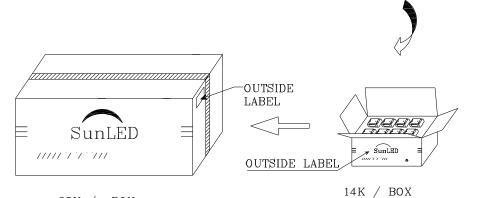
# PACKING & LABEL SPECIFICATIONS

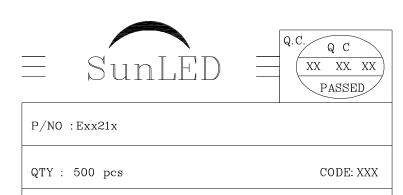
28K / BOX

S/N : XX

Published Date: MAR 21, 2008







LOT NO:

Drawing No : SDSA3725

V3

RoHS Compliant